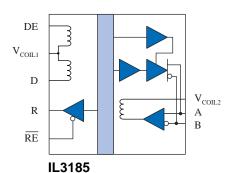
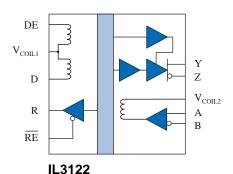


# Low Cost RS-485 and RS-422 Isolated Transceivers

## **Functional Diagrams**





#### **IL3185 Truth Table**

$V_{(A-B)}$	DE	D	R	RE	Mode
≥ 200 mV	Н	Н	Н	L	Drive
≤-200 mV	Н	L	L	L	Drive
≥ 200 mV	L	X	Н	L	Receive
≤-200 mV	L	X	L	L	Receive
X	X	X	Z	Н	X
Open	L	X	Н	L	Receive

Z = High ImpedanceX = Irrelevant

#### **IL3122 Receiver**

$\overline{\mathbf{RE}}$	R	$V_{(A-B)}$
Н	Z	X
L	Н	≥ 200 mV
L	L	≤−200 mV
L	Н	Open

#### **IL3122 Driver**

DE	D	$V_{(Y-Z)}$
L	X	Z
Н	Н	≥ 200 mV
Н	L	≤−200 mV

#### **Selection Table**

Model	Full/Half Duplex	No. of Devices Allowed on Bus	Data Rate Mbps	Fail-Safe
IL3185	half	32	5	yes
IL3122	full	32	5	yes

#### **Features**

- 3.3 V / 5 V Input Supply Compatible
- 5 Mbps Data Rate
- Supports Up to 32 Nodes
- ±15 kV ESD Protection
- 15 kV bus ESD protection
- 2500 V<sub>RMS</sub> Isolation (1 minute)
- 20 kV/µs Typical Common Mode Rejection
- Low EMC Footprint
- Thermal Shutdown Protection
- -40°C to +85°C Temperature Range
- UL1577 and IEC 61010-2001 Approved
- 0.15" or 0.3" 16-pin SOIC Packages

## **Applications**

- · P.O.S. Systems
- Security Networks
- Building Environmental Controls
- Industrial Control Networks
- Gaming Systems
- Factory Automation

#### Description

The IL3185 and IL3122 are galvanically isolated, differential bus transceivers designed for bidirectional data communication over balanced transmission lines. The devices use NVE's patented\* IsoLoop spintronic Giant Magnetoresistance (GMR) technology. The IL3185 delivers at least 1.5 V into a 54  $\Omega$  load, and the IL3122 at least 2 V into a  $100 \Omega$  load, allowing excellent data integrity over long cables. These devices are also compatible with 3.3 V input supplies, allowing interface to standard microcontrollers without additional level shifting.

Both the IL3185 and IL3122 have current limiting and thermal shutdown features to protect against output short circuits and bus contentions that may cause excessive power dissipation. The receivers also incorporate a "fail-safe if open" design, ensuring a logic high on R if the bus lines are disconnected or "floating."

A capacitor ( $C_{Boost}$ ; see page 7) must be placed across the current limit resistor to ensure the full specified performance.

IsoLoop® is a registered trademark of NVE Corporation. \*U.S. Patent number 5,831,426; 6,300,617 and others.

REV. L



### **Absolute Maximum Ratings**

Operating at absolute maximum ratings will not damage the device. However, extended periods of operation at the absolute maximum ratings may affect performance and reliability.

Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Storage Temperature	$T_s$	-65		150	°C	
Ambient Operating Temperature	$T_A$	-40		85	°C	
Voltage Range at A or B Bus Pins		-7		12	V	
Supply Voltage (1)	$V_{DD1}, V_{DD2}$	-0.5		7	V	
Digital Input Voltage		-0.5		$V_{DD} + 0.5$	V	
Digital Output Voltage		-0.5		$V_{DD}+1$	V	
ESD Protection		±15			kV	
Input Current	$I_{\rm IN}$	-25		+25	mA	
ESD (all bus nodes)		15			kV	HBM

Note 1. All voltage values are with respect to network ground except differential I/O bus voltages.

**Recommended Operating Conditions** 

Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Supply Voltage	$egin{array}{c} V_{ ext{DD1}} \ V_{ ext{DD2}} \end{array}$	3.0 4.5		5.5 5.5	V	
Ambient Operating Temperature	$T_{A}$	-40		85	°C	
Input Voltage at any Bus Terminal (separately or common mode)	$egin{array}{c} V_{ m I} \ V_{ m IC} \end{array}$			12 -7	V	
Input Threshold for Output Logic High	$I_{INH}$		1.5	0.8	mA	
Input Threshold for Output Logic Low	$I_{INL}$	5	3.5		mA	
Differential Input Voltage (2)	$ m V_{ID}$			+12/-7	V	
High-Level Output Current (Driver)	$I_{OH}$	-60		60	mA	
High-Level Digital Output Current (Receiver)	$I_{OH}$	-8		8	mA	
Low-Level Output Current (Driver)	$I_{OL}$	-60		60	mA	
Low-Level Digital Output Current (Receiver)	$I_{OL}$	-8		8	mA	
Ambient Operating Temperature	$T_{A}$	-40		85	°C	
Digital Input Signal Rise, Fall Times	$t_{\rm IR}, t_{\rm IF}$			1	μs	

**Insulation Specifications** 

Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Creepage Distance (external)		8.08			mm	
Barrier Impedance			>10 <sup>14</sup>   7		$\Omega \parallel pF$	
Leakage Current			0.2		μΑ	240 V <sub>RMS</sub> , 60 Hz

## Safety Approvals

### IEC61010-2001

TUV Certificate Numbers: N1502812, N1502812-101

Classification: Reinforced Insulation

		Pollution	Material	Max. Working
Model	Package	Degree	Group	Voltage
IL3122E, IL3185E, IL3122-3E, IL3185-3E	SOIC (0.15" and 0.3")	II	III	$300 V_{RMS}$

## **UL 1577**

Rated 2500  $V_{\text{RMS}}$  for 1 minute

Component Recognition Program File Number: E207481

Soldering Profile

Per JEDEC J-STD-020C, MSL=2

Electrostatic Discharge Sensitivity

This product has been tested for electrostatic sensitivity to the limits stated in the specifications. However, NVE recommends that all integrated circuits be handled with appropriate care to avoid damage. Damage caused by inappropriate handling or storage could range from performance degradation to complete failure.



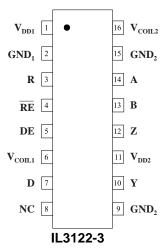
## IL3185-3 Pin Connections (0.15" SOIC Package)

1	$V_{DD1}$	Input power supply
2	$GND_1$	Ground return for V <sub>DD1</sub>
3	R	Output data from bus
4	RE	Read enable (if RE is high, R is high impedance)
5	DE	Drive enable
6	$V_{\text{COIL1}}$	Coils for DE and D (connect to V <sub>DD1</sub> )
7	D	Data input to bus
8	NC	No internal connection
9	$\mathrm{GND}_2$	Ground return for V <sub>DD2</sub> (internally connected to pin 15)
10	NC	No internal connection
11	$V_{\mathrm{DD2}}$	Output power supply
12	A	Non-inverting bus line
13	В	Inverting bus line
14	NC	No internal connection
15	$\mathrm{GND}_2$	Ground return for V <sub>DD2</sub> (internally connected to pin 9)
16	$V_{\text{COIL2}}$	Coil for R (connect to V <sub>DD2</sub> )

## $V_{COIL2}$ 15 **GND**<sub>2</sub> $GND_1$ 2 $\mathbf{R}$ 3 14 NC $\overline{RE}$ $\boxed{4}$ **DE** 5 $\mathbf{V}_{\mathrm{COIL1}}$ 6 11 $V_{DD2}$ 10 NC **D** 7 NC 8 9 **GND**<sub>2</sub> IL3185-3

## IL3122-3 Pin Connections (0.15" SOIC Package)

1	$V_{\mathrm{DD1}}$	Input power supply
2	$GND_1$	Ground return for V <sub>DD1</sub>
3	R	Output data from bus
4	RE	Read enable (if RE is high, R is high impedance)
5	DE	Drive enable
6	$V_{COIL1}$	Coils for DE and D (connect to V <sub>DD1</sub> )
7	D	Data input to bus
8	NC	No internal connection
9	$GND_2$	Ground return for V <sub>DD2</sub> (internally connected to pin 15)
10	Y	Non-inverting driver bus line
11	$V_{\mathrm{DD2}}$	Output power supply
12	Z	Inverting driver bus line
13	В	Inverting receiver bus line
14	A	Non-inverting receiver bus line
15	$\mathrm{GND}_2$	Ground return for V <sub>DD2</sub> (internally connected to pin 9)
16	$V_{COIL2}$	Coil for R (connect to V <sub>DD2</sub> )





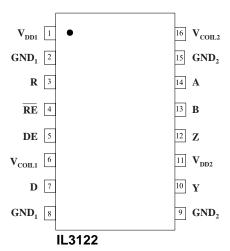
## IL3185 Pin Connections (0.3" SOIC Package)

		· · · · · · · · · · · · · · · · · · ·
1	$V_{DD1}$	Input power supply
2	$GND_1$	Ground return for V <sub>DD1</sub>
3	R	Output data from bus
4	RE	Read enable (if RE is high, R is high impedance)
5	DE	Drive enable
6	$V_{COIL1}$	Coils for DE and D (connect to V <sub>DD1</sub> )
7	D	Data input to bus
8	$\mathrm{GND}_1$	Internally connected to pin 2 for 0.3" package; no internal connection on 0.15" IL3285-3
9	$\mathrm{GND}_2$	Ground return for V <sub>DD2</sub> (internally connected to pin 15)
10	NC	No internal connection
11	$V_{\mathrm{DD2}}$	Output power supply
12	A	Non-inverting bus line
13	В	Inverting bus line
14	NC	No internal connection
15	$\mathrm{GND}_2$	Ground return for V <sub>DD2</sub> (internally connected to pin 9)
16	$V_{\text{COIL2}}$	Coil for R (connect to V <sub>DD2</sub> )

### $\mathbf{V_{DD1}}$ 1 16 V<sub>COIL2</sub> $GND_1$ 2 15 **GND**<sub>2</sub> 14 NC $\mathbf{R}$ 3 13 **B** RE 4 12 **A DE** 5 $\mathbf{V}_{\mathrm{COIL1}}$ $oxed{6}$ 11 $V_{DD2}$ 10 NC **D** 7 $GND_1$ 8 9 GND<sub>2</sub> IL3185

## IL3122 Pin Connections (0.3" SOIC Package)

1	$V_{DD1}$	Input power supply
2	$GND_1$	Ground return for V <sub>DD1</sub>
3	R	Output data from bus
4	RE	Read enable (if RE is high, R is high impedance)
5	DE	Drive enable
6	$V_{COIL1}$	Coils for DE and D (connect to V <sub>DD1</sub> )
7	D	Data input to bus
8	$\mathrm{GND}_1$	Internally connected to pin 2 for 0.3" package; no internal connection on 0.15" IL3285-3
9	$\mathrm{GND}_2$	Ground return for V <sub>DD2</sub> (internally connected to pin 15)
10	Y	No internal connection
11	$V_{\mathrm{DD2}}$	Output power supply
12	Z	Non-inverting bus line
3	В	Inverting bus line
14	A	No internal connection
15	$\mathrm{GND}_2$	Ground return for V <sub>DD2</sub> (internally connected to pin 9)
16	$V_{\text{COIL2}}$	Coil for R (connect to V <sub>DD2</sub> )







## **Driver Section**

Electrical specifications are  $T_{min}$  to  $T_{max}$  unless otherwise stated.

Electrical specifications are $T_{min}$ to $T_{max}$ ur <b>Parameters</b>	Symbol	Min.	Тур.	Max.	Units	Test Conditions
		IVIII.		IVIAA.		$T_{AMB} = 25^{\circ}C$
Coil Input Impedance	$Z_{COIL}$		85  9		Ω  nH	$V_{DD} = 3.0 \text{ V to } 5.5 \text{ V}$
Temperature Coefficient of Coil Resistance	$TC\ R_{COIL}$		0.2	0.25	Ω/°C	$V_{DD} = 3.0 \text{ V to } 5.5 \text{ V}$
Output voltage				$V_{\scriptscriptstyle  m DD}$	V	$I_0 = 0$
Differential Output Voltage	$ V_{OD1} $			$V_{\scriptscriptstyle DD}$	V	$I_0 = 0$
Differential Output Voltage	$ V_{\mathrm{OD2}} $	2	3	22	V	$R_L = 100 \Omega, V_{DD} = 5 V$
Differential Output Voltage <sup>(6)</sup>	V <sub>OD3</sub>	1.5	2.3		V	$R_L = 54 \Omega$ , $V_{DD} = 5 V$
Change in Magnitude <sup>(7)</sup> of Differential Output Voltage	$\Delta  V_{ m OD} $			±0.2	V	$R_L = 54 \Omega \text{ or } 100 \Omega$
Common Mode Output Voltage	V <sub>OC</sub>			3	V	$R_L = 54 \Omega \text{ or } 100 \Omega$
Change in Magnitude <sup>(7)</sup> of Common Mode Output Voltage	$\Delta  V_{OC} $			0.2	V	$R_L = 54 \Omega \text{ or } 100 \Omega$
Output Current <sup>(4)</sup>				1 -0.8	mA mA	Output disabled, $V_0 = 12 \text{ V}$ $V_0 = -7 \text{ V}$
High Level Input Current	$ m I_{IH}$			0.8	mA	
Low Level Input Current	${ m I}_{ m I\!L}$	5	3.5		mA	
Short-circuit Output Current	$I_{OS}$	60		250	mA	$-7 \text{ V} < \text{V}_{\text{O}} < 12 \text{ V}$
Supply Current $(V_{DD2} = +5 \text{ V})$ $(V_{DD1} = +5 \text{ V})$	$egin{array}{l} egin{array}{l} egin{array}$		6 2.5	7 3	mA	No Load (Outputs Enabled)
Supply Current $(V_{DD1} = +3.3 \text{ V})$	$I_{\mathrm{DD2}}$		1.3	2	mA	No Load (Outputs Enabled)
	Switching Spec	cifications ( $V_I$	$c_{DD1} = +5 \text{ V, } C_{bo}$	ost = 16pF		
Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Data Rate		5			Mbps	$R_L = 54 \Omega, C_L = 50 pF$
Differential Output Prop Delay	$t_D(OD)$		40	65	ns	$R_L = 54 \Omega, C_L = 50 pF$
Pulse Skew <sup>(10)</sup>	t <sub>SK</sub> (P)		6	15	ns	$R_L = 54 \Omega, C_L = 50 pF$
Differential Output Rise and Fall Time	t <sub>T</sub> (OD)	3	12	25	ns	$R_L = 54 \Omega, C_L = 50 pF$
Output Enable Time to High Level	t <sub>PZH</sub>		25	40	ns	$R_L = 54 \Omega, C_L = 50 pF$
Output Enable Time to Low Level	$t_{\mathrm{PZL}}$		25	40	ns	$R_L = 54 \Omega, C_L = 50 pF$
Output Disable Time from High Level	$t_{\mathrm{PHZ}}$		25	40	ns	$R_L = 54 \Omega, C_L = 50 pF$
Output Disable Time from Low Level	$t_{\rm PLZ}$		25	40	ns	$R_L = 54 \Omega, C_L = 50 pF$
Skew Limit <sup>(3)</sup>	$t_{SK}(LIM)$			8	ns	$R_L = 54 \Omega$ , $C_L = 50pF$
Common Mode Rejection	$ CM_H ,  CM_L $	15	20		kV/μs	$V_T = 300 V_{peak}$
	Switching Speci	fications (V <sub>DI</sub>	$c_{01} = +3.3 \text{ V}, C_{b}$			
Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Data Rate		5			Mbps	$R_L = 54 \Omega, C_L = 50 pF$
Differential Output Prop Delay	$t_D(OD)$		40	65	ns	$R_L = 54 \Omega, C_L = 50 pF$
Pulse Skew <sup>(10)</sup>	$t_{SK}(P)$		6	20	ns	$R_L = 54 \Omega, C_L = 50 pF$
Differential Output Rise and Fall Time	$t_{T}(OD)$	3	12	25	ns	$R_L = 54 \Omega, C_L = 50 pF$
Output Enable Time to High Level	$t_{\mathrm{PZH}}$		25	40	ns	$R_L = 54 \Omega, C_L = 50 pF$
Output Enable Time to Low Level	$t_{\mathrm{PZL}}$		25	40	ns	$R_L = 54 \Omega, C_L = 50 pF$
Output Disable Time from High Level	$t_{ m PHZ}$		25	40	ns	$R_L = 54 \Omega, C_L = 50 pF$
Output Disable Time from Low Level	$t_{ m PLZ}$		25	40	ns	$R_L = 54 \Omega, C_L = 50 pF$
Skew Limit <sup>(3)</sup>	$t_{SK}(LIM)$			8	ns	$R_L = 54 \Omega$ , $C_L = 50pF$
Common Mode Rejection	$ CM_H ,  CM_L $	15	20		kV/μs	$V_T = 300 V_{peak}$



## **Receiver Section**

Electrical specifications are  $T_{min}$  to  $T_{max}$  unless otherwise stated.

Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Coil Input Impedance	Z <sub>COIL</sub>		85  9		$\Omega    nH$	$T_{AMB} = 25$ °C $V_{DD} = 3.0 \text{ V to } 5.5 \text{ V}$
Temperature Coefficient of Coil Resistance	TC R <sub>COIL</sub>		0.2	0.25	Ω/°C	$V_{DD} = 3.0 \text{ V to } 5.5 \text{ V}$
Positive-going Input Threshold	$V_{IT+}$			0.2	V	$-7 \text{ V} < \text{V}_{\text{CM}} < 12 \text{ V}$
Negative-going Input Threshold	$V_{IT-}$	-0.2			V	$-7 \text{ V} < \text{V}_{\text{CM}} < 12 \text{ V}$
Hysteresis Voltage (V <sub>it+</sub> – V <sub>it-</sub> )	$V_{HYS}$		70		mV	$V_{CM} = 0V, T = 25^{\circ}C$
High Level Digital Output Voltage	$V_{OH}$	$V_{DD} - 0.2$	$V_{\rm DD} - 0.2$		V	$V_{\rm ID} = 200 \text{ mV}$
						$I_{OH} = 4 \text{ mA}$
Low Level Digital Output Voltage	$V_{OL}$			0.8	V	$V_{\rm ID} = -200 \text{ mV}$
						$I_{OL} = 4 \text{ mA}$
High impedance state output current	$I_{OZ}$			10	μΑ	$0.4 \le V_O \le (V_{DD2} - 0.5) V$
Line Input Current <sup>(8)</sup>	$I_{\mathrm{I}}$			1	mA	$V_I = 12 \text{ V}$
				-0.8		$V_I = -7 \text{ V}$
Input Resistance	$r_{\mathrm{I}}$	12	25		kΩ	
	Switching Cha	racteristics (V <sub>1</sub>	$c_{DD1} = +5 \text{ V}, C_{bo}$	$p_{oost} = 16pF$		
Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Data Rate		5			Mbps	$R_L = 54 \Omega, C_L = 50 \text{ pF}$
Propagation Delay <sup>(9)</sup>	t <sub>PD</sub>		50	85	ns	$-1.5 \le V_O \le 1.5 V,$ $C_L = 15 pF$
Pulse Skew <sup>(10)</sup>	t <sub>SK</sub> (P)		10	17	ns	$-1.5 \le V_O \le 1.5 \text{ V},$ $C_L = 15 \text{ pF}$
Skew Limit <sup>(3)</sup>	t <sub>SK</sub> (LIM)		2	8	ns	$R_L = 54 \Omega, C_L = 50 \text{ pF}$
Output Enable Time to High Level	t <sub>PZH</sub>		4	40	ns	$C_L = 15 \text{ pF}$
Output Enable Time to Low Level	t <sub>PZL</sub>		4	40	ns	$C_L = 15 \text{ pF}$
Output Disable Time from High Level	t <sub>PHZ</sub>		4	40	ns	$C_L = 15 \text{ pF}$
Output Disable Time from Low Level	$t_{\rm PLZ}$		4	40	ns	$C_L = 15 \text{ pF}$
•	Switching Char	acteristics (V <sub>D</sub>	$D_1 = +3.3 \text{ V, } C_1$	$p_{\text{poost}} = 16 \text{pF}$		
Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Data Rate	-	5			Mbps	$R_L = 54 \Omega, C_L = 50 \text{ pF}$
Propagation Delay <sup>(9)</sup>	t <sub>PD</sub>		55	85	ns	$-1.5 \le V_O \le 1.5 \text{ V},$ $C_L = 15 \text{ pF}$
Pulse Skew <sup>(10)</sup>	t <sub>SK</sub> (P)		12	20	ns	$-1.5 \le V_O \le 1.5 \text{ V},$ $C_L = 15 \text{ pF}$
Skew Limit <sup>(3)</sup>	t <sub>SK</sub> (LIM)		4	10	ns	$R_L = 54 \Omega, C_L = 50 \text{ pF}$
Output Enable Time to High Level	t <sub>PZH</sub>		5	10	ns	$C_L = 15 \text{ pF}$
Output Enable Time to Low Level	t <sub>PZL</sub>		5	10	ns	$C_L = 15 \text{ pF}$
Output Disable Time from High Level	t <sub>PHZ</sub>		5	10	ns	$C_L = 15 \text{ pF}$
Output Disable Time from Low Level	$t_{PLZ}$		17	10	ns	$C_L = 15 \text{ pF}$

#### Notes (apply to both driver and receiver sections):

- 1. All voltages are with respect to network ground except differential I/O bus voltages.
- 2. Differential input/output voltage is measured at the non-inverting terminal A with respect to the inverting terminal B.
- 3. Skew limit is the maximum difference in any two channels in one device.
- 4. The power-off measurement in ANSI Standard EIA/TIA-422-B applies to disabled outputs only and is not applied to combined inputs and outputs.
- 5. All typical values are at  $V_{DD1}$ ,  $V_{DD2} = 5$  V or  $V_{DD1} = 3.3$  V and  $T_A = 25$ °C.
- 6. While  $-7 \text{ V} < V_{\text{CM}} < 12 \text{ V}$ , the minimum  $V_{\text{OD2}}$  with a 54  $\Omega$  load is either  $\frac{1}{2} V_{\text{OD1}}$  or 1.5 V, whichever is greater.
- 7.  $\Delta |VOD|$  and  $\Delta |VOC|$  are the changes in magnitude of  $V_{OD}$  and  $V_{OC}$ , respectively, that occur when the input is changed from one logic state to the other.
- 8. This applies for both power on and power off; refer to ANSI standard RS-485 for exact condition. The EIA/TIA-422-B limit does not apply for a combined driver and receiver terminal.
- 9. Includes 10 ns read enable time. Maximum propagation delay is 25 ns after read assertion.
- 10. Pulse skew is defined as the  $|t_{PLH}-t_{PHL}|$  of each channel.



#### Power Supply Decoupling

Both  $V_{DD1}$  and  $V_{DD2}$  must be bypassed with 47 nF ceramic capacitors. These should be placed as close as possible to  $V_{DD}$  pins for proper operation. Additionally, V<sub>DD2</sub> should be bypassed with a 10 µF tantalum capacitor.

#### Operation

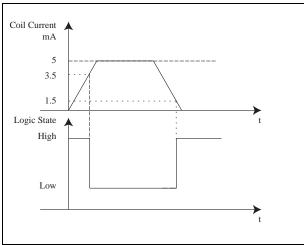


Figure 1. IL3000 Series Input Transfer Function

The IL3122 and IL3185 are current-mode devices. Changes in input coil current switch internal spintronic GMR sensors, which then change the logic state of the outputs. The GMR bridge is designed so the output of the isolator is logic high when no field signal is present.

A single resistor is required to limit the input coil current to the recommended 5 mA. The absolute maximum current through any coil is 25 mA DC. Although logic threshold currents are typically less than the worst-case 5 mA, NVE recommends designing for 5 mA logic threshold current in all applications.

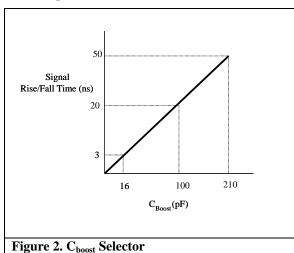
Figure 1 shows the input response of the IL3122 and IL3185. Output logic high is the zero input current state. The output switches to the low state with approximately 3.5 mA of coil current, and back to the high state when the input current falls below approximately 1.5 mA. This allows glitch-free interface with low slew-rate signals.

## **Typical Resistor Values**

$V_{COIL}$	0.125W, 5% Resistor
3.3 V	510 Ω
5 V	820 Ω

The table shows typical values for the external resistor in 5 V and 3 V logic systems. As always, these values as approximate and should be adjusted for temperature or other application specifics If the expected temperature range is large, 1% tolerance resistors may provide additional design margin.

## **Boost Capacitor**



The boost capacitor in parallel with the current-limiting resistor boosts the instantaneous coil current at the signal transition. The boost current pushes the GMR bridge output through the comparator threshold voltage in a bipolar fashion providing important magnetic centering and very reliable switching. Select the value of the boost capacitor based on the rise and fall times of the signal driving the inputs.

Use the chart as a guide to boost capacitor selection. The capacitor value is generally not critical, and can often vary  $\pm 50\%$  with little noticeable difference in device performance provided the center value is correct. If in doubt, choose a value higher than indicated, up to a maximum of 470 nF. Note however that power dissipation in the input coil increases in proportion to the capacitor value.

The correct boost capacitor gives a great deal of design headroom and can usually eliminate design concerns related to temperature and power supply fluctuations.



#### **Magnetic Field Immunity**

IsoLoop devices operate by imposing a magnetic field on a GMR sensor, which translates the change in field into a change in logic state. The devices are manufactured with a magnetic shield above the sensor. The shield acts as a flux concentrator to boost the magnetic signal from the internal coil, and as a shield against external magnetic fields. The shield absorbs surrounding stray flux until it becomes saturated. At saturation the shield is transparent to external applied fields, and the GMR sensor may react to the field. To compensate for this effect, IsoLoop Isolators use Wheatstone Bridge structures that are only sensitive to differential magnetic fields. There are several ways to further enhanced the magnetic field immunity of IL3000 Transceivers. Providing a larger internal field will reduce the effect of an external field on the GMR sensor. Immunity to external magnetic fields can also be enhanced by proper orientation of the device with respect to the field direction and field boosting capacitors.

## Orientation of the device with respect to the field direction

An applied field in the "H1" direction is the worst case for magnetic immunity. In this case the external field is in the same

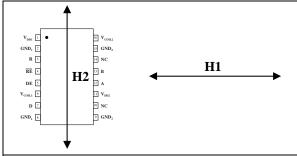


Figure 3. Orientation of External Magnetic Field

direction as the applied internal field. In one direction it will tend to help switching; in the other it will hinder switching. This can cause unpredictable operation.

An applied field in the direction of "H2" has considerably less effect on the sensor and will result in significantly higher immunity levels as shown in Table 1.

The greatest magnetic immunity is achieved by adding the current boost capacitor across the input resistor. Very high immunity can be achieved with this method.

Method	<b>Approximate Immunity</b>	Immunity Description	
Field applied in direction H1	+20 Gauss	A DC current of 16 A flowing in a conductor	
Tield applied in direction III	±20 Gauss	1 cm from the device could cause disturbance	
Field applied in direction H2	+70 Gauss	A DC current of 56 A flowing in a conductor	
Field applied in direction H2	±70 Gauss	1 cm from the device could cause disturbance	
Field applied in any direction but with field	1250 Carras	A DC current of 200 A flowing in a conductor	
booster capacitor (470 pF) in circuit	±250 Gauss	1 cm from the device could cause disturbance	
Table 1. Magnetic Immunity			

## **Data Rate and Magnetic Field Immunity**

It is easier to disrupt an isolated DC signal with an external magnetic field than it is to disrupt an isolated AC signal. Similarly, a DC magnetic field will have a greater effect on the device than an AC magnetic field of the same effective magnitude. For example, signals with pulses greater than  $100 \, \mu s$  long are more susceptible to magnetic fields than shorter pulse widths. For input signals faster than  $1 \, MHz$ , rising in less than  $3 \, ns$ , a  $470 \, pF$  field-boost capacitor provides as much as  $400 \, Gauss$  immunity, while the same input capacitor might provide just  $70 \, Gauss$  of immunity at  $50 \, kHz$ .

©NVE Corporation



### **Applications Information**

RS-485 and RS-422 are differential (balanced) data transmission standards for use over long distances or in noisy environments. RS-422 is an RS-485 subset, so RS-485 transceivers are also RS-422-compliant. RS-422 is a multi-drop standard allowing only one driver and up to 10 receivers on each bus (assuming unit load receivers). RS-485 is a true multipoint standard which allows up to 32 unit load devices (any combination of drivers and receivers) on each bus. To allow for multipoint operation, RS-485 requires drivers to handle bus contention without damage. Another important advantage of RS-485 is the extended common-mode range (CMR), which requires driver outputs and receiver inputs withstand +12 V to -7 V. RS-422 and RS-485 are intended for runs as long as 4,000 feet (1,200 m), so the wide CMR is necessary for ground potential differences, as well as voltages induced in the cable by external fields.

## Receiver Features

IL3000 transceivers have differential input receivers for maximum noise immunity and common-mode rejection. Input sensitivity is  $\pm 200$  mV as required by the RS-422 and RS-485 specifications. The receivers include a "fail-safe if open" function that guarantees a high level receiver output if the receiver inputs are unconnected (floating). Receivers easily meet the data rates supported by the corresponding driver. IL3000-Series receiver outputs have tri-state capabilities with active low RE inputs.

#### **Driver Features**

The RS485/422 driver is a differential output device that delivers at least 1.5 V across a 54  $\Omega$  load (RS-485), and at least 2 V across a 100  $\Omega$  load (RS-422). The driver features low propagation delay skew to maximize bit width and minimize EMI. IL3222 and IL3285 drivers have tri-state capability with an active high DE input.

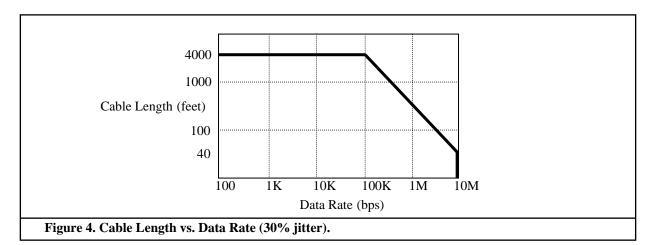
#### Cabling, Data Rate and Terminations

#### Cabling:

Use twisted-pair cable. The cable can be unshielded if it is short (<10 m) and the data rate is slow (<100 Kbps). Otherwise, use screened cable with the shield tied to earth ground at one end only. Do not tie the shield to digital ground. The other end of the shield may be tied to earth ground through an RC network. This prevents a DC ground loop in the shield. Shielded cable minimizes EMI emissions and external noise coupling to the bus.

#### Data Rate:

The longer the cable, the slower the data rate. The RS-485 bus can transmit ground over 4,000 feet (1,200 m) or at 10Mbps, but not both at the same time. Transducer and cable characteristics combine to act as a filter with the general response shown in Figure 4. Other parameters such as acceptable jitter affect the final cable length versus data rate tradeoff. Less jitter means better signal quality but shorter cable lengths or slower data rates. Figure 4 shows a generally accepted 30% jitter and a corresponding data rate versus cable length.





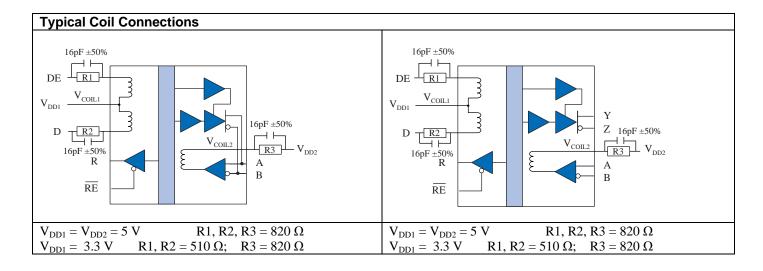
## Terminations:

Transmission lines should be terminated to avoid reflections that cause data errors. In RS-485 systems both ends of the bus, not every node, should be terminated. In RS-422 systems only the receiver end should be terminated.



Proper termination is imperative when using IL3185 and IL3122 to minimize reflections. Unterminated lines are only suitable for very low data rates and very short cable runs, otherwise line reflections cause problems. Parallel terminations are the most popular. They allow high data rates and excellent signal quality.

Occasionally in noisy environments, fast pulses or noise appearing on the bus lines cause errors. One way of alleviating such errors without adding circuit delays is to place a series resistor in the bus line. Depending on the power supply, the resistor should be between 300  $\Omega$  (3 V supply) and 500  $\Omega$  (5 V supply).





## Fail-Safe Operation:

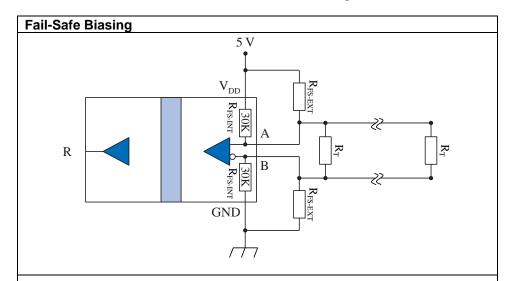
"Fail-safe operation" is defined here as the forcing of a logic high state on the "R" output in response to an open-circuit condition between the "A" and "B" lines of the bus, or when no drivers are active on the bus.

Proper biasing can ensure fail-safe operation, that is a known state when there are no active drivers on the bus. IL3000-Series Isolated Transceivers include internal pull-up and pull-down resistors of approximately  $30~k\Omega$  in the receiver section ( $R_{FS-INT}$ ; see figure below). These internal resistors are designed to ensure failsafe operation but only if there are no termination resistors. The entire  $V_{DD}$  will appear between inputs "A" and "B" if there is no loading and no termination resistors, and there will be more than the required 200 mV with up to four RS-485/RS-422 worst-case Unit Loads of  $12~k\Omega$ . Many designs operating below 1 Mbps or less than 1,000 feet are unterminated. Termination resistors may not be necessary for very low data rates and very short cable runs because reflections have time to settle before data sampling, which occurs at the middle of the bit interval.

In busses with low-impedance termination resistors, however, the differential voltage across the conductor pair will be close to zero with no active drivers. In this case the state of the bus is indeterminate, and the idle bus will be susceptible to noise. For example, with  $120~\Omega$  termination resistors ( $R_T$ ) on each end of the cable, and four Unit Loads ( $12~k\Omega$  each), without external failsafe biasing resistors the internal pull-up and pull-down resistors will produce a voltage between inputs "A" and "B" of only about 5 mV. This is not nearly enough to ensure a known state. External fail-safe biasing resistors ( $R_{FS-EXT}$ ) at one end of the bus can ensure fail-safe operation with a terminated bus. Resistors should be selected so that under worst-case power supply and resistor tolerances there is at least 200 mV across the conductor pair with no active drivers to meet the input sensitivity specification of the RS-422 and RS-485 standards.

Using the same value for pull-up and pull-down biasing resistors maintains balance for positive- and negative going transitions. Lower-value resistors increase inactive noise immunity at the expense of quiescent power consumption. Note that each Unit Load on the bus adds a worst-case loading of  $12 \text{ k}\Omega$  across the conductor pair, and 32 Unit Loads add  $375 \Omega$  worst-case loading. The more loads on the bus, the lower the required values of the biasing resistors.

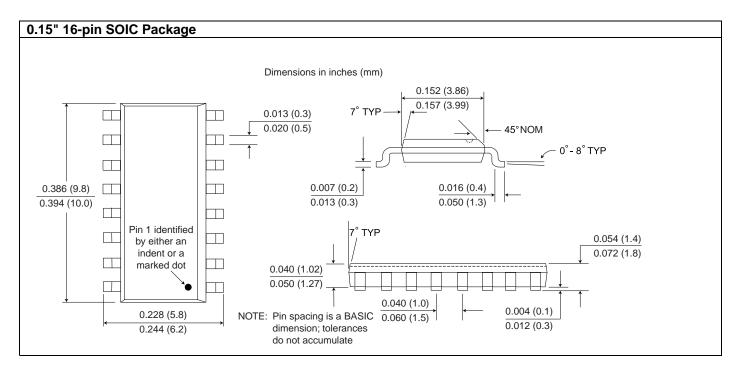
In the example with two 120  $\Omega$  termination resistors and four Unit Loads, 560  $\Omega$  external biasing resistors provide more than 200 mV between "A" and "B" with adequate margin for power supply variations and resistor tolerances. This ensures a known state when there are no active drivers. Other illustrative examples are shown in the table below.

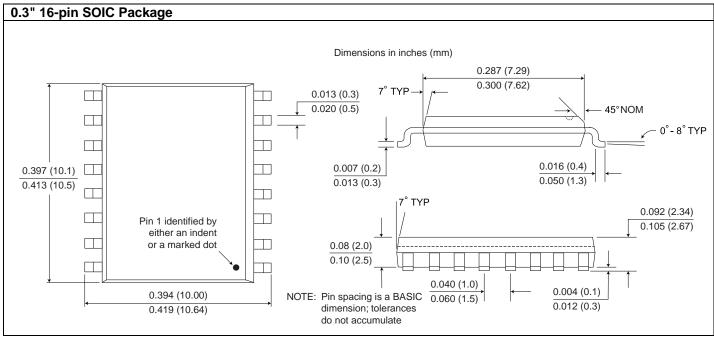


R <sub>FS-EXT</sub>	$\mathbf{R}_{\mathrm{T}}$	Loading	Nominal V <sub>A-B</sub> (inactive)	Fail-Safe Operation?
Internal Only	None	Four unit loads (12 k $\Omega$ ea.)	238 mV	Yes
Internal Only	120 Ω	Four unit loads (12 k $\Omega$ ea.)	5 mV	No
560 Ω	120 Ω	Four unit loads (12 k $\Omega$ ea.)	254 mV	Yes
510 Ω	120 Ω	32 unit loads (12 k $\Omega$ ea.)	247 mV	Yes



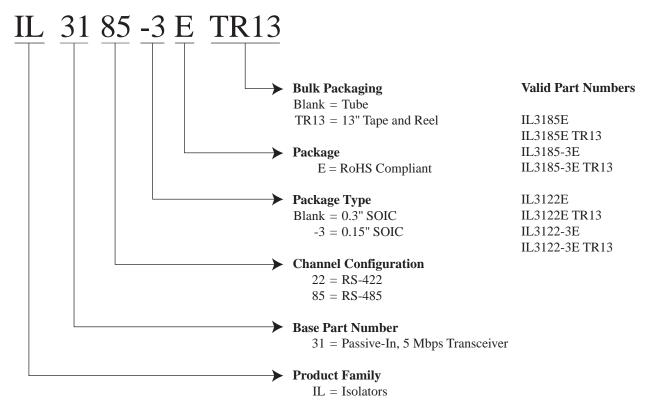
### Package Drawings, Dimensions and Specifications







## **Ordering Information and Valid Part Numbers**



RoHS COMPLIANT



 	~ . ~ .	٠и.	story

Revision History	
ISB-DS-001-IL3185/22-L	Changes
February 2012	<ul> <li>Update terms and conditions.</li> </ul>
ISB-DS-001-IL3185/22-K	Changes
	• Clarified ground pin connections (pp. 3-4).
ISB-DS-001-IL3185/22-J	Changes
	• Changes to current-limiting resistor values (pp. 7 and 10).
	• Details for boost capacitor selection (p. 7).
ISB-DS-001-IL3185/22-I	Changes
	Noted UL1577 approval.
ISB-DS-001-IL3185/22-H	Changes
	• Added bus-protection ESD specification (15 kV).
ISB-DS-001-IL3185/22-G	Changes
	<ul> <li>Added typical coil resistance and temperature coefficient specifications.</li> </ul>
	Added note on package drawings that pin-spacing tolerances are non-accumulating.
ISB-DS-001-IL3185/22-F	Changes
1015-100 1-110 100/22-1	• Changed ordering information to reflect that devices are now fully RoHS compliant with
	no exemptions.
ISB-DS-001-IL3185/22-E	Changes
	Eliminated soldering profile chart
ISB-DS-001-IL3185/22-D	Changes
	<ul> <li>Separate pinout diagrams for narrow- and wide-body packages</li> </ul>
ISB-DS-001-IL3185/22-C	Changes
	Added "Open" input condition to truth tables
	Fail-safe biasing section added
	Narrow-body-SOIC packages added
ISB-DS-001-IL3185/22-B	Changes
	1. Capacitor Information added on page 1
	2. Input Signal Rise/Fall times changed from 10 μs to 1μs
	<ol> <li>Typical coil formations show C<sub>Boost</sub></li> <li>Switching characteristics show C<sub>Boost</sub> = 16 pF</li> </ol>
ISB-DS-001-IL3185/22-A	Initial Release



#### **Datasheet Limitations**

The information and data provided in datasheets shall define the specification of the product as agreed between NVE and its customer, unless NVE and customer have explicitly agreed otherwise in writing. All specifications are based on NVE test protocols. In no event however, shall an agreement be valid in which the NVE product is deemed to offer functions and qualities beyond those described in the datasheet.

#### Limited Warranty and Liability

Information in this document is believed to be accurate and reliable. However, NVE does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NVE be liable for any indirect, incidental, punitive, special or consequential damages (including, without limitation, lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

#### Right to Make Changes

NVE reserves the right to make changes to information published in this document including, without limitation, specifications and product descriptions at any time and without notice. This document supersedes and replaces all information supplied prior to its publication.

#### **Use in Life-Critical or Safety-Critical Applications**

Unless NVE and a customer explicitly agree otherwise in writing, NVE products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical devices or equipment. NVE accepts no liability for inclusion or use of NVE products in such applications and such inclusion or use is at the customer's own risk. Should the customer use NVE products for such application whether authorized by NVE or not, the customer shall indemnify and hold NVE harmless against all claims and damages.

## **Applications**

Applications described in this datasheet are illustrative only. NVE makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NVE products, and NVE accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NVE product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customers. Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NVE does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customers. The customer is responsible for all necessary testing for the customer's applications and products using NVE products in order to avoid a default of the applications and the products or of the application or use by customer's third party customers. NVE accepts no liability in this respect.

#### **Limiting Values**

Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the recommended operating conditions of the datasheet is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

#### **Terms and Conditions of Sale**

In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NVE hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NVE products by customer.

#### No Offer to Sell or License

Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

#### **Export Control**

This document as well as the items described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

#### **Automotive Qualified Products**

Unless the datasheet expressly states that a specific NVE product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NVE accepts no liability for inclusion or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NVE's warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NVE's specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NVE for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NVE's standard warranty and NVE's product specifications.



An ISO 9001 Certified Company

NVE Corporation 11409 Valley View Road Eden Prairie, MN 55344-3617 USA Telephone: (952) 829-9217

Fax: (952) 829-9189 www.nve.com

e-mail: iso-info@nve.com

# ©NVE Corporation

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

ISB-DS-001-IL3185/22-L

February 2012